STEALTH[™] Diode

15 A, 600 V

ISL9R1560G2, ISL9R1560P2, ISL9R1560S3S

Description

The ISL9R1560G2, ISL9R1560P2, ISL9R1560S3S is a STEALTH diode optimized for low loss performance in high frequency hard switched applications. The STEALTH family exhibits low reverse recovery current (I_{rr}) and exceptionally soft recovery under typical operating conditions. This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low I_{rr} and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the STEALTH diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.

Features

- Stealth Recovery $t_{rr} = 29.4$ ns (@ $I_F = 15$ A)
- Max Forward Voltage, $V_F = 2.2 V (@ T_C = 25^{\circ}C)$
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- These Devices are Pb-Free and are RoHS Compliant

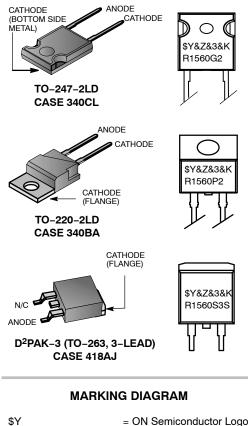
Applications

- SMPS
- Hard Switched PFC Boost Diode
- UPS Free Wheeling Diode
- Motor Drive FWD
- SMPS FWD
- Snubber Diode



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\$Y	= ON Semiconductor Logo
&Z	= Assembly Plant Code
&3	= Numeric Date Code
&K	= Lot Code
R1560G2, R1560P2,	
R1560S3S	= Specific Device Code

SYMBOL



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

DEVICE MAXIMUM RATINGS ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Repetitive Peak Reverse Voltage	V _{RRM}	600	V
Working Peak Reverse Voltage	V _{RWM}	600	V
DC Blocking Voltage	V _R	600	V
Average Rectified Forward Current ($T_C = 145^{\circ}C$)	I _{F(AV)}	15	А
Repetitive Peak Surge Current (20 kHz Square Wave)	I _{FRM}	30	А
Non-repetitive Peak Surge Current (Halfwave 1 Phase 60 Hz)	I _{FSM}	200	А
Power Dissipation	PD	150	W
Avalanche Energy (1 A, 40 mH)	E _{AVL}	20	mJ
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +175	°C
Maximum Temperature for Soldering Leads at 0.063 in (1.6 mm) from Case for 10 s Package Body for 10 s, See Techbrief TB334	T _L T _{PKG}	300 260	°C °C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
ISL9R1560G2	R1560G2	TO-247-2LD	Tube	N/A	N/A	30
ISL9R1560P2	R1560P2	TO-220-2LD	Tube	N/A	N/A	50
ISL9R1560S3ST	R1560S3S	TO-263(D ² -PAK)	Reel	13″ dia	24 mm	800

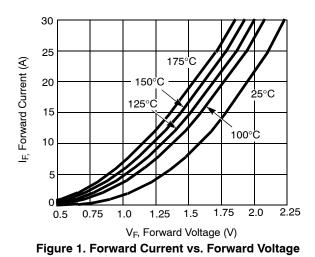
THERMAL CHARACTERISTICS

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Thermal Resistance Junction to Case	$R_{\theta JC}$		-	-	1.0	°C/W
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	TO-247	-	-	30	°C/W
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	TO-220	-	-	62	°C/W
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	TO-263	_	_	62	°C/W

Junction Capacitance	I _R V _F	V _R = 600 V	$T_C = 25^{\circ}C$ $T_C = 125^{\circ}C$	-	-	100	μΑ
On State Characteristics Instantaneous Forward Voltage Dynamic Characteristics Junction Capacitance Switching Characteristics		V _R = 600 V			-	100	^
Instantaneous Forward Voltage Dynamic Characteristics Junction Capacitance Switching Characteristics	V _F		T _C = 125°C				μΑ
Instantaneous Forward Voltage Oynamic Characteristics Junction Capacitance Switching Characteristics	V _F	-	-	-	-	1.0	mA
Dynamic Characteristics Junction Capacitance Switching Characteristics	V_{F}						
Junction Capacitance Switching Characteristics		I _F = 15 A	$T_{C} = 25^{\circ}C$	-	1.8	2.2	V
Switching Characteristics			T _C = 125°C	-	1.65	2.0	V
Switching Characteristics							
<u> </u>	CJ	$V_{R} = 10 \text{ V}, \text{ I}_{F} = 0 \text{ A}$		-	62	_	pF
Reverse Recovery Time							
	t_{rr} I _F = 1 A, dI _F /dt = 100 A/µs, V _R = 30 V			-	25	30	ns
		I_F = 15 A, dI_F/dt = 100 A/µs, V_R = 30 V		-	35	40	ns
Reverse Recovery Time	t _{rr}	$I_{F} = 15 \text{ A},$ $dI_{F}/dt = 200 \text{ A}/\mu\text{s},$ $V_{B} = 390 \text{ V},$		-	29.4	-	ns
Reverse Recovery Current	I _{rr}			-	3.5	-	Α
Reverse Recovered Charge	Q _{rr}	$T_{C} = 25^{\circ}C$	$T_{\rm C} = 25^{\circ}{\rm C}$		57	-	nC
Reverse Recovery Time	t _{rr}			-	90	-	ns
Softness Factor (t _b / _{ta})	S			-	2.0	-	
Reverse Recovery Current	I _{rr}			-	5.0	-	Α
Reverse Recovered Charge	Q _{rr}			-	275	-	nC
Reverse Recovery Time	t _{rr}	I _F = 15 A, dI _F /dt = 800 A/μs, V _R = 390 V, T _C = 125°C		-	52	-	ns
Softness Factor (t _b / _{ta})	S			-	1.36	-	
Reverse Recovery Current	I _{rr}			_	13.5	-	Α
Reverse Recovered Charge	Q _{rr}			_	390	_	nC
Maximum di/dt During t _b	••			1	030	_	1

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

TYPICAL PERFORMANCE CURVES



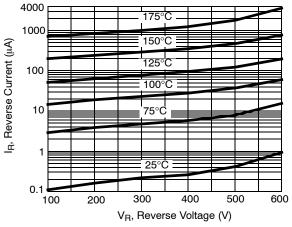


Figure 2. Reverse Current vs. Reverse Voltage

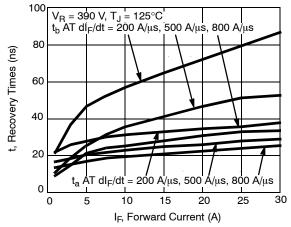
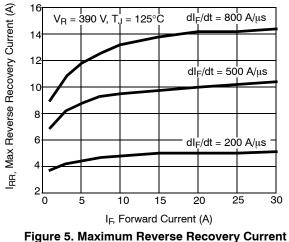


Figure 3. t_a and t_b Curves vs. Forward Current



vs. Forward Current

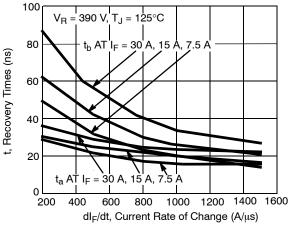
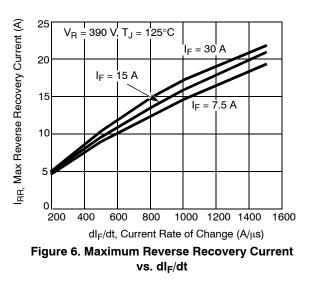


Figure 4. t_a and t_b Curves vs. $dI_{\mbox{\scriptsize F}}/dt$



TYPICAL PERFORMANCE CURVES (continued)

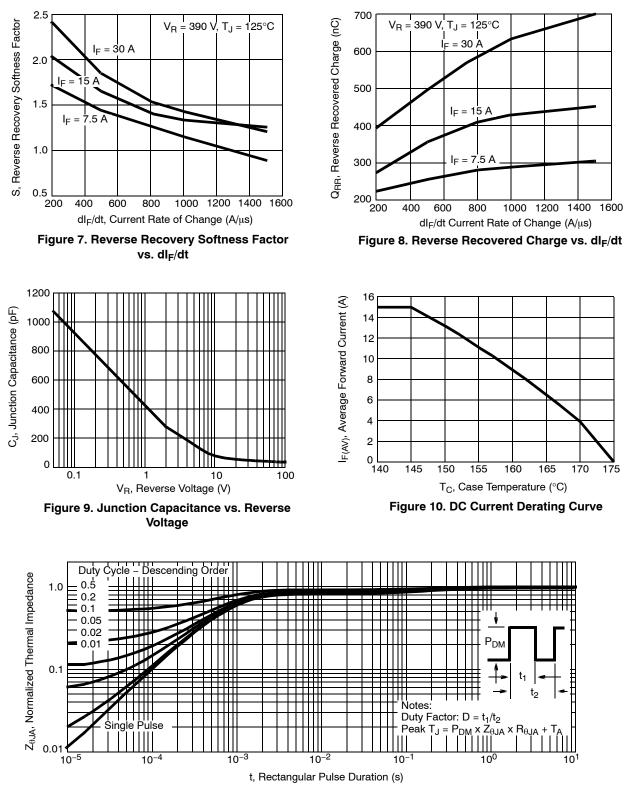
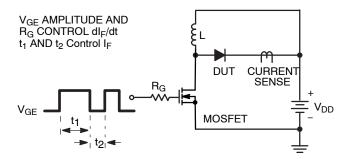
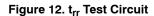


Figure 11. Normalized Maximum Transient Thermal Impedance

TEST CIRCUIT AND WAVEFORMS





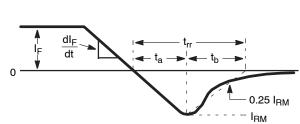


Figure 13. t_{rr} Waveforms and Definitions

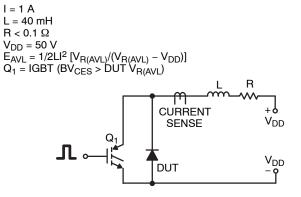


Figure 14. Avalanche Energy Test Circuit

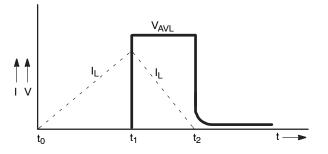


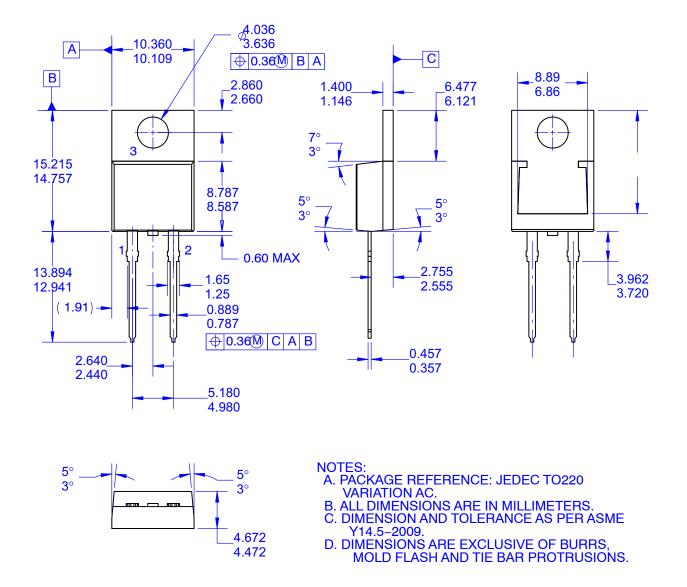
Figure 15. Avalanche Current and Voltage Waveforms

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MILLIMETERS

NOM

4.70

2.40

1.50

1.26

1.65

0.61

20.57

16.57

0.93

15.62

~

5.08

11.12

16.00

3.81

3.58

6.73

5.46

5.46

MAX

4.82

2.66

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20.82

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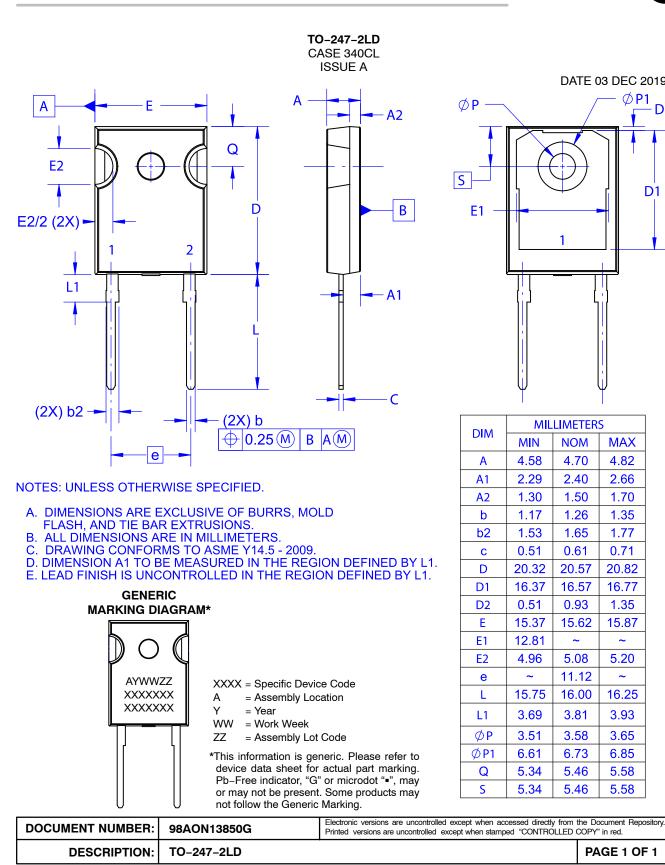
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ØP1



D2

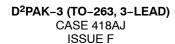
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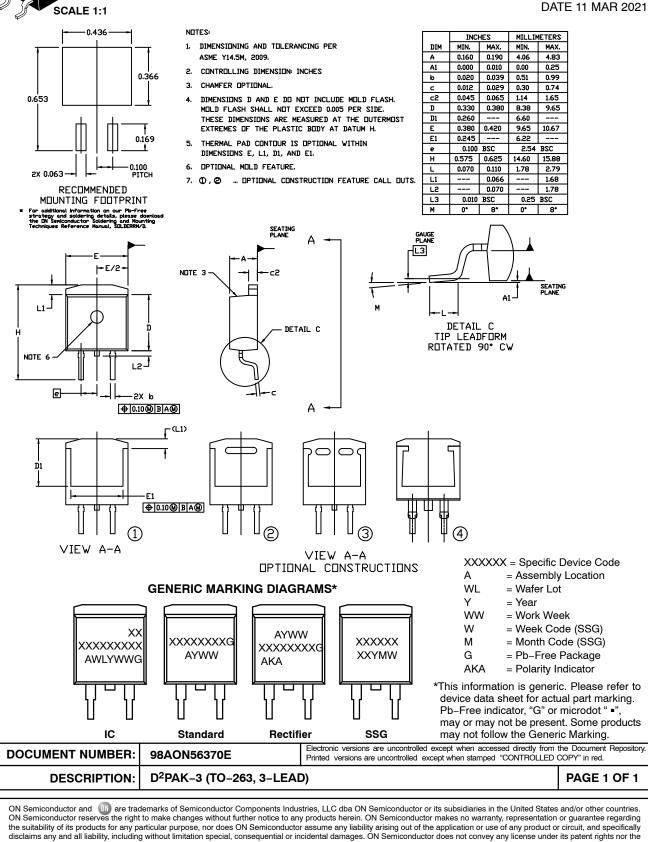
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